



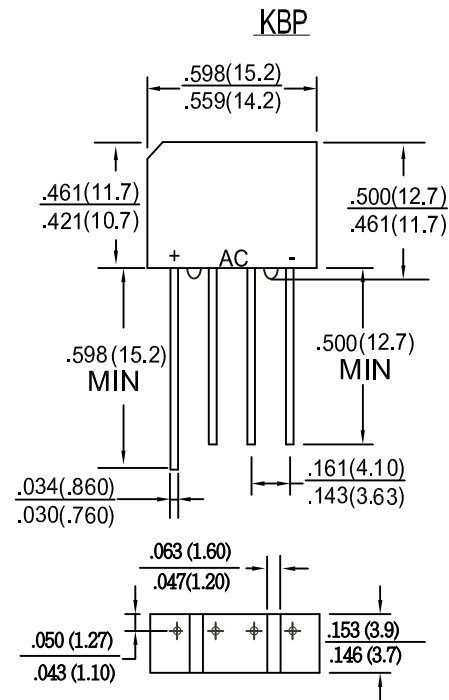
SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIERS

FEATURES:

- Ideal for printed circuit board mounting
- The plastic material carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed 265 °C / 10 seconds

MECHANICAL DATA

Case : Reliable low cost construction utilizing
 Terminals : Plated leads solderable per MIL-STD-202,
 Method 208
 Mounting Position Any
 Weight : 0.065 ounce, 2.2grams



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temp. unless otherwise specified.
 Single phase, half sine wave, 60 Hz, resistive or inductive load.
 For capacitive load, derate current by 20 %.

Characteristic	Symbol	KBP 201G	KBP 202G	KBP 203G	KBP 204G	KBP 206G	KBP 208G	KBP 210G	Units
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current at Ta=50°C	I _O	2.0							Amps
Peak forward surge current single sine-wave on rated load (JEDEC Method)	I _{FSM}	60							Amps
Maximum instantaneous forward voltage drop per leg at 2.0 A	V _F	1.1							Volts
Maximum DC reverse current at rated DC blocking voltage per leg	I _R	10 500							μ A
Typical thermal resistance	R _{th-JL}	25							°C/W
Operating junction and storage temperature range	T _j , T _{stg}	-55 to 165							°C



RATINGS AND CHARACTERISTIC CURVES

FIG.1-MAXIMUM FORWARD CURRENT DERATING CURVE

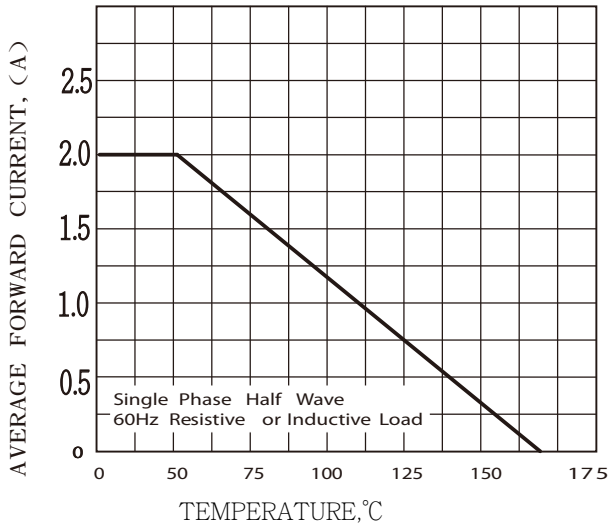


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

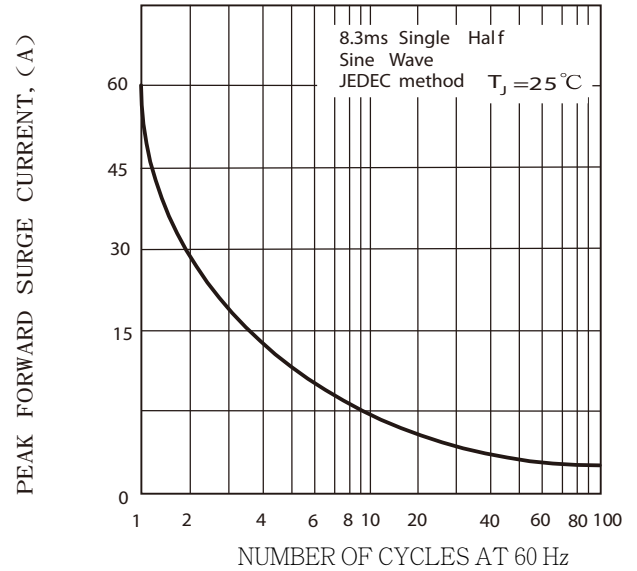


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER BRIDGE ELEMENT

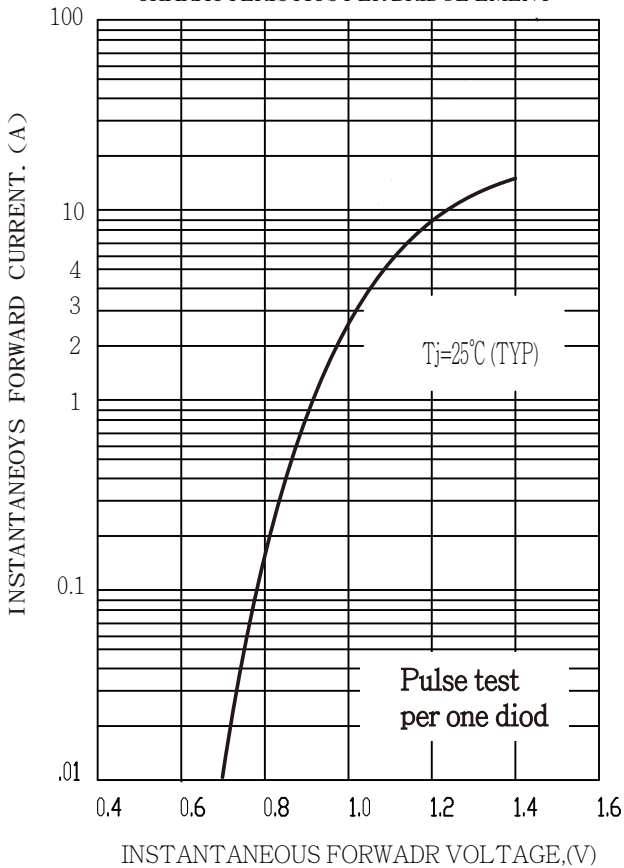
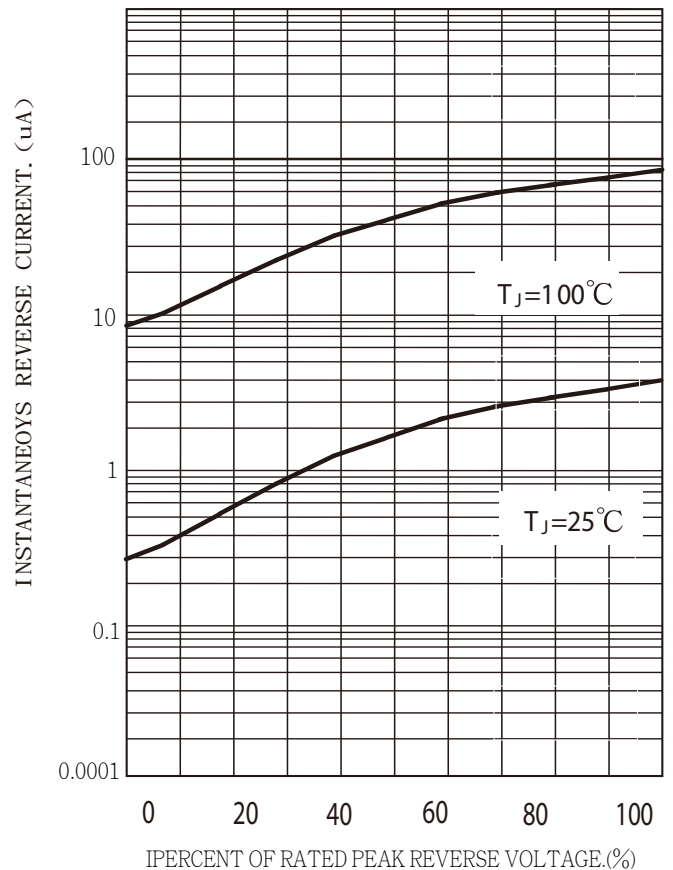


FIG.4-TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT





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